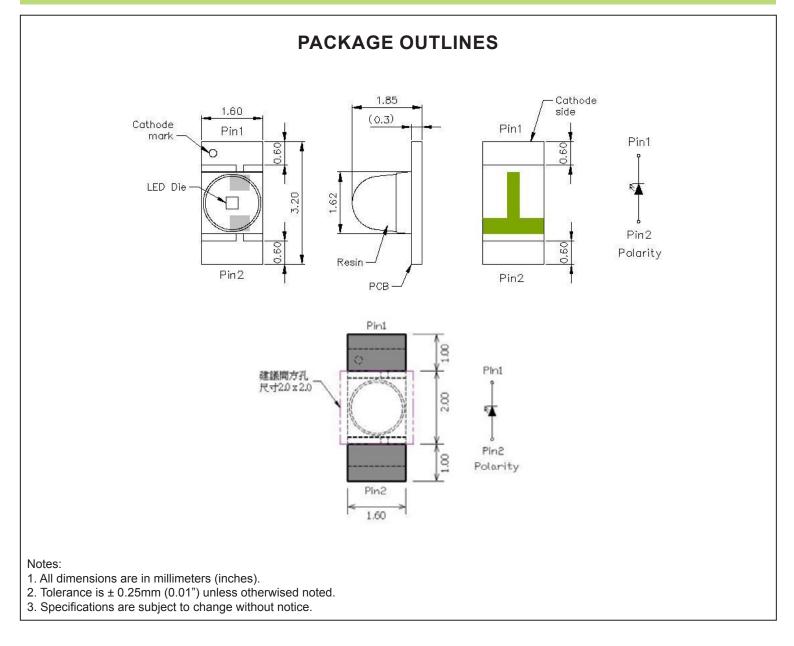


#### SPECIFICATION

# CSD126AA3C-R



Part Number	Chip Material	Color of Emission	Lens Type	Viewing Angle
CSD126AA3C-R	InGaAIP	Amber	Water Clear	20°





### **ABSOLUTE MAXIMUM RATINGS**

#### (TA=25°C)

Parameter	Symbol	Max Rating	Unit
Forward Current	lF	20	mA
Reverse Current @ 5V	lR	10	μA
Power Dissipation	Pd	48	mW
Operating Temperature Range	Тор	-40~+85	°C
Storage Temperature Range	Тѕтс	-40~+100	°C
Peak Pulsing Current (1/10 duty f = 10KHz)	lfp	40	mA
Soldering Temperature	TSOL	Max 260°C for 10 sec Max	

# OPTICAL-ELECTRICAL CHARACTERISTICS

(TA=25°C)

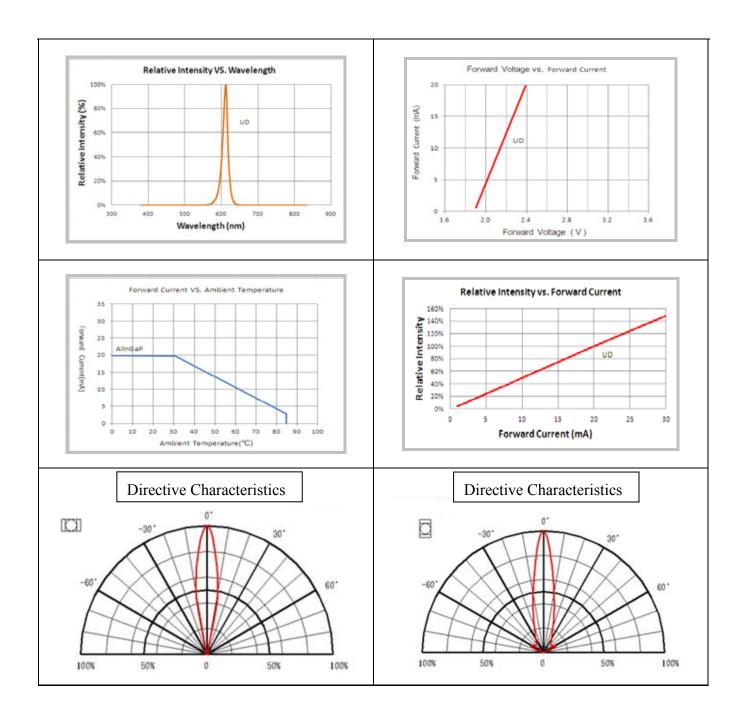
Deremeter	Symbol	Test Condition	Value			Linit
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Luminous Intensity	١v	IF = 20mA	1125	1800	-	mcd
Forward Voltage	Vf	IF = 20mA	-	2.0	2.4	V
Reverse Leakage Current	lr	VR = 5V	-	10	-	μA
Viewing Angle at 50% Iv	201/2	IF = 20mA	-	20	-	Deg
Peak Wavelength	λP	IF = 20mA	-	611	-	nm
Dominant Wavelength	λD	IF = 20mA	-	605	-	nm

\*Tolerance of viewing angle: -10 / +5 deg.





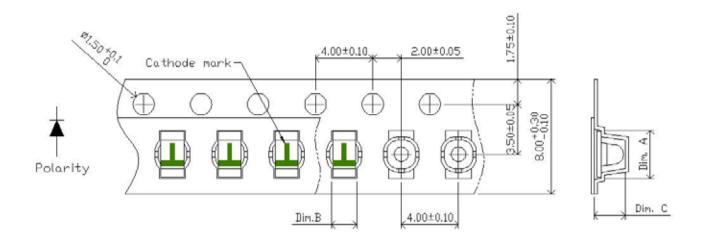
# **OPTICAL CHARACTERISTIC CURVES**



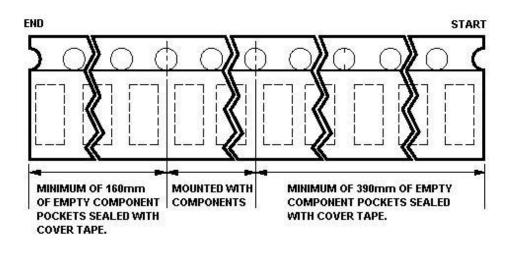




# PACKAGING SPECIFICATION



Dim. A	Dim. B	Dim. C	Q'ty/Reel
3.37±0.1	1.78±0.1	2.17±0.1	2K







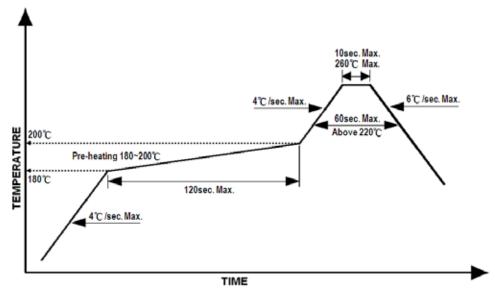
### **SOLDERING CONDITIONS**

#### **Reflow Soldering**

Recommend soldering paste specifications:

- 1. Operating temp.: Above 220 ℃ ,60 sec.
- 2. Peak temp.:260 ℃Max.,10sec Max.
- 3. Reflow soldering should not be done more than two times.
- 4. Never attempt next process until the component is cooled down to room temperature after reflow.
- 5. The recommended reflow soldering profile (measured on the surface of the LED terminal) is as following:

Lead-free Solder Profile



#### Reworking

- Rework should be completed within 5 seconds under 260°C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

